

Electronic Acknowledgement Receipt

EFS ID:	1179029
Application Number:	10612281
Confirmation Number:	5797
Title of Invention:	Bond finger on via substrate, process of making same, package made thereby, and method of assembling same
First Named Inventor:	Brian Taggart
Customer Number:	21186
Filer:	Joseph P. Mehrle/Anne Richards
Filer Authorized By:	Joseph P. Mehrle
Attorney Docket Number:	884.853US1
Receipt Date:	30-AUG-2006
Filing Date:	30-JUN-2003
Time Stamp:	16:45:44
Application Type:	Utility
International Application Number:	

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		853preappealSIGNED.pdf	138460	yes	6

	Multipart Description		
	Doc Desc	Start	End
	Transmittal letter	1	1
	Notice of Appeal Filed	2	2
	Pre-Brief Conference request	3	6
Warnings:			
Information:			
Total Files Size (in bytes):		138460	
<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p><u>New Applications Under 35 U.S.C. 111</u> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p><u>National Stage of an International Application under 35 U.S.C. 371</u> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p>			